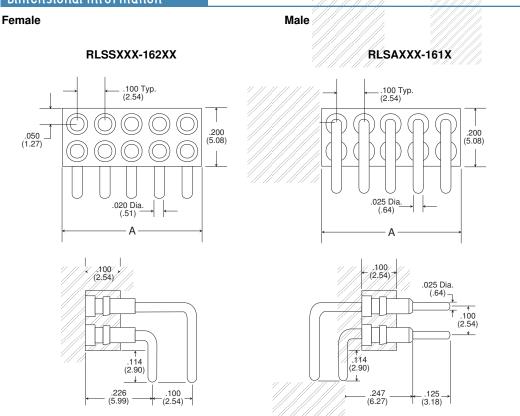
Dual Row Right Angle Board to Board Connectors .100/(2.54mm) Pitch • Molded Insulators

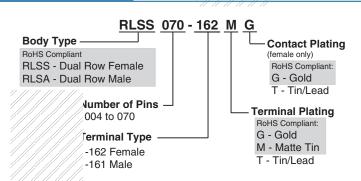
Description: Molded Dual Row (RLSS) Material: High Temp. Liquid Crystal Polymer (LCP) Index: -40°C to 260°C (-40°F to 500°F) Description: Molded Dual Row (RLSA) Material: High Temp. Liquid Crystal Polymer (LCP) Index: -40°C to 260°C (-40°F to 500°F)

Dimensional Information



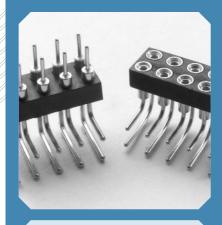
A = Pitch .100/(2.54mm) x Number of Terminals in Row

How To Order



Note: Terminals plated with Matte Tin are available only with Gold plated contacts.

Board to Board Connectors



Features:

- High reliability method of interconnecting PCB to PCB.
- .025/(.64mm) diameter male pins.
- .100/(2.54mm) row to row pitch.
- Screw-machined terminals with multi-finger contacts.

Specifications:

Terminals:

Brass - Copper Alloy (C36000) ASTM-B-16

Contacts:

Beryllium Copper (C17200) ASTM-B-194

Plating:

RoHS Compliant Pb Free G - Gold over Nickel

M - Matte Tin over Nickel

T - Tin/Lead over Nickel

Gold per ASTM-B-488 Matte Tin per ASTM545-97 Tin/Lead per MIL-P-81728 Nickel per QQ-N-290



5 Energy Way, West Warwick, RI 02893 USA Tel: 800.424.9850 | 401.823.5200 Fax: 401.823.8723 info@advanced.com | www.advanced.com Catalog 16